



(CRT HORIZONTAL DEFLECTION)
HIGH VOLTAGE DAMPER DIODE

FEATURES

- HIGH BREAKDOWN VOLTAGE CAPABILITY
- HIGH FREQUENCY OPERATION
- SPECIFIED TURN ON SWITCHING CHARACTERISTICS
- TYPICAL TOTAL LOSSES : 3.5W
($I_{Fpeak} = 6$ A, $F = 64$ kHz)
- SUITABLE WITH BUH TRANSISTORS SERIES
- INSULATED VERSION (ISOWATT220AC) :
Insulating voltage = 2000 V DC
Capacitance = 12 pF

DESCRIPTION

High voltage diode especially designed for horizontal deflection stage in standard and high resolution displays for TV's and monitors.

This device is packaged in TO220AC or ISOWATT220AC.



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter			Value	Unit
$I_F(RMS)$	RMS forward current			15	A
$I_F(AV)$	Average forward current $\delta = 0.5$	TO220AC	$T_c=130^\circ C$	6	A
		ISOWATT220AC	$T_c=110^\circ C$	6	
I_{FSM}	Surge non repetitive forward current		$tp=10ms$ sinusoidal	100	A
T_{stg} T_j	Storage and junction temperature range			- 40 to + 150	$^\circ C$
				- 40 to + 150	$^\circ C$

Symbol	Parameter	DTV32(F)-		Unit
		1200B	1500B	
V_{RRM}	Repetitive peak reverse voltage	1200	1500	V
V_{RWM}	Reverse working voltage	1000	1350	V

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th} (j-c)	Junction to case	TO220AC	2
		ISOWATT220AC	4

ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
I _R *	T _j = 25°C	V _R = V _{RWM}			200	μA
	T _j = 100°C				1	mA
V _F **	T _j = 25°C	I _F = 6 A			1.5	V
	T _j = 100°C	I _F = 6 A			1.4	

Pulse test : * tp = 5 ms, duty cycle < 2 %

** tp = 380 μs, duty cycle < 2 %

RECOVERY CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
trr (1)	T _j = 25°C	I _F = 1 A V _R = 30 V	dI _F /dt = -50 A/μs			175	ns
						250	ns
trr	T _j = 25°C	I _F = 100mA	I _R = 100mA		140		ns

TURN ON SWITCHING CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
t _{FR} (2)	T _j = 100°C	I _F = 6 A V _{FR} = 2 V	dI _F /dt = 80 A/μs		0.6		μs
					39		V

(1) Test following Jedec Standard

(2) Test representative of the application

To evaluate the conduction losses use the following equations :

$$V_F = 1.2 + 0.034 I_F$$

$$P = 1.2 \times I_{F(AV)} + 0.034 \times I_{F(RMS)}^2$$

Fig.1 : Average forward power dissipation versus average forward current.

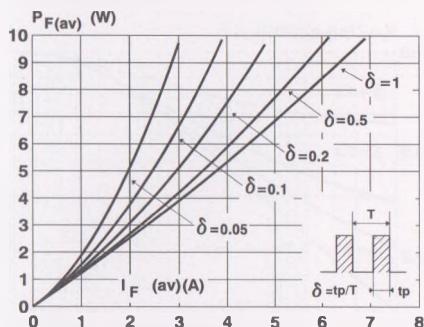


Fig.3 : Average current versus ambient temperature. (duty cycle : 0.5) (TO220AC)

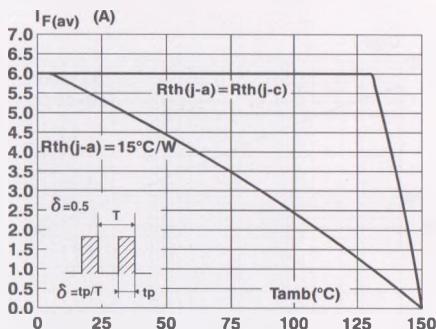


Fig.5 : Non repetitive surge peak forward current versus overload duration.
(Maximum values) (TO220AC)

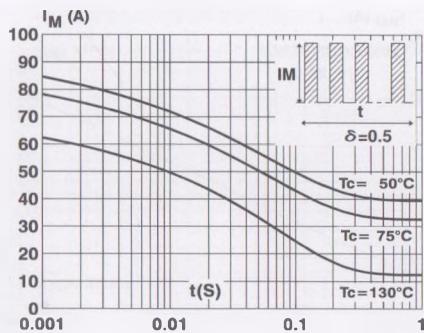


Fig.2 : Peak current versus form factor.

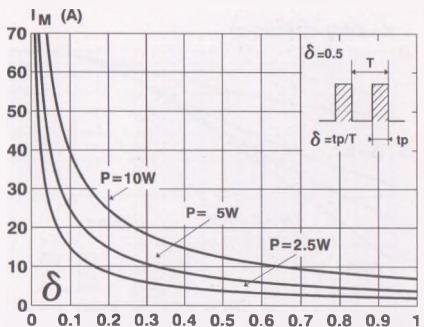


Fig.4 : Average current versus ambient temperature. (duty cycle : 0.5) (ISOWATT220AC)

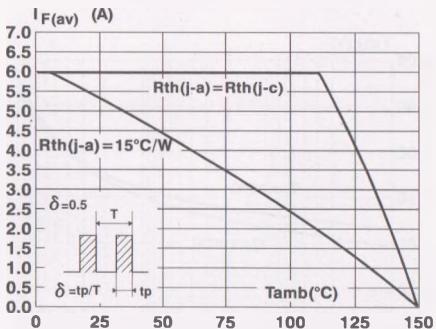
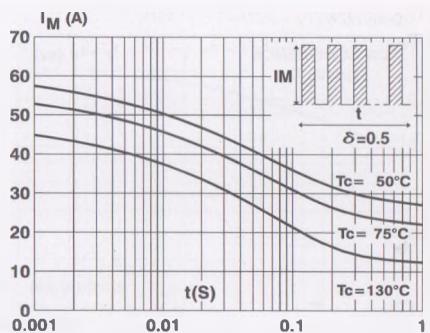


Fig.6 : Non repetitive surge peak forward current versus overload duration.
(Maximum values) (ISOWATT220AC)



DTV32(F)-1200B / DTV32(F)-1500B

Fig.7 : Relative variation of thermal transient impedance junction to case versus pulse duration.
(TO220AC)

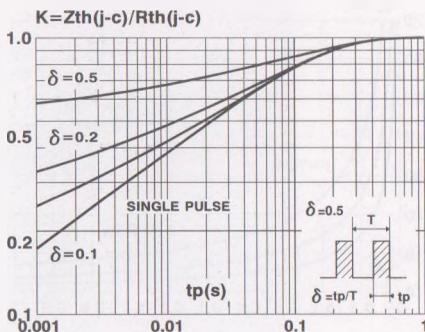


Fig.9 : Forward voltage drop versus forward current.
(Maximum values)

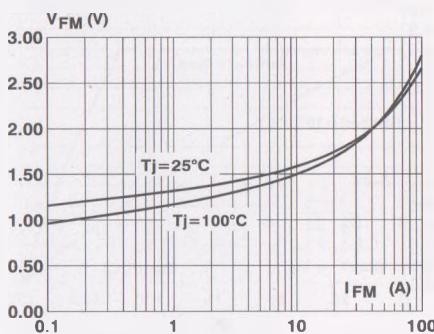


Fig.11 : Recovery charge versus dI/F/dt.

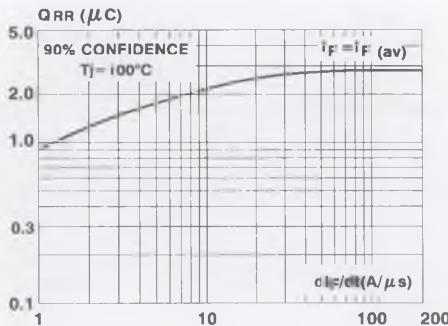


Fig.8 : Relative variation of thermal transient impedance junction to case versus pulse duration.
(ISOWATT220AC)

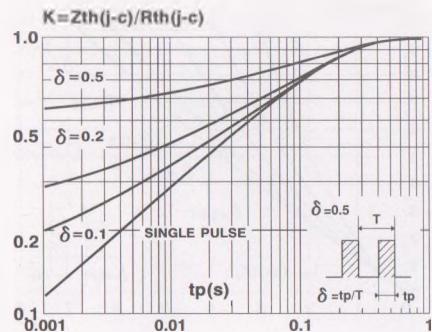


Fig.10 : Junction capacitance versus reverse voltage applied.
(Typical values)

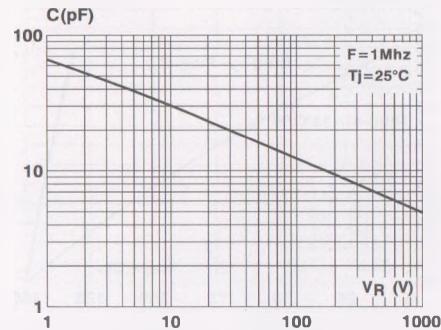


Fig.12 : Peak reverse current versus dI/F/dt.

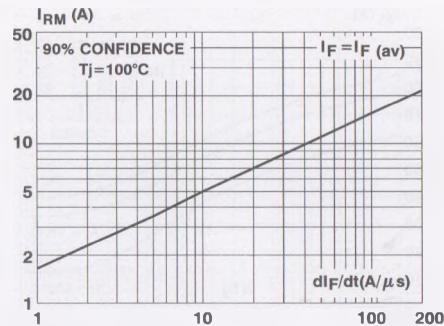


Fig.13 : Dynamic parameters versus junction temperature.

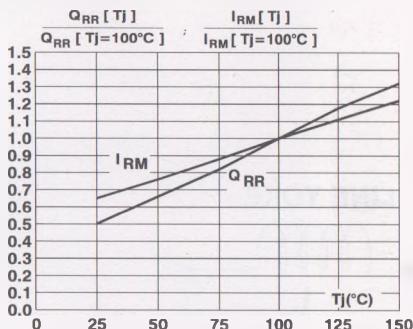


Fig.14 : Peak forward voltage versus dI_F/dt .

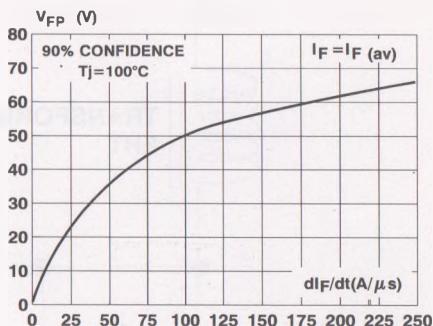
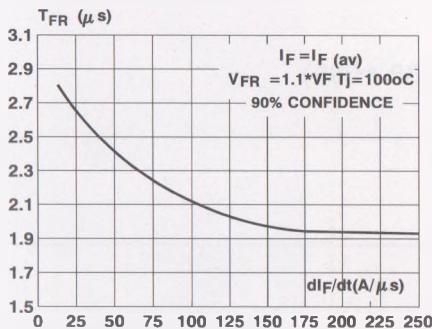
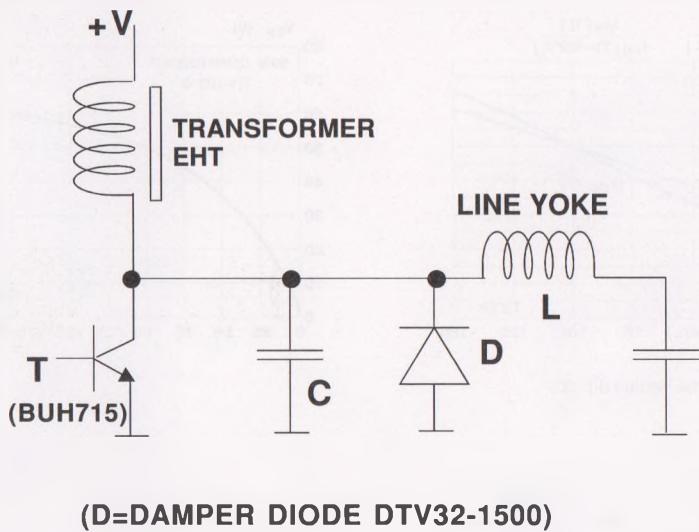


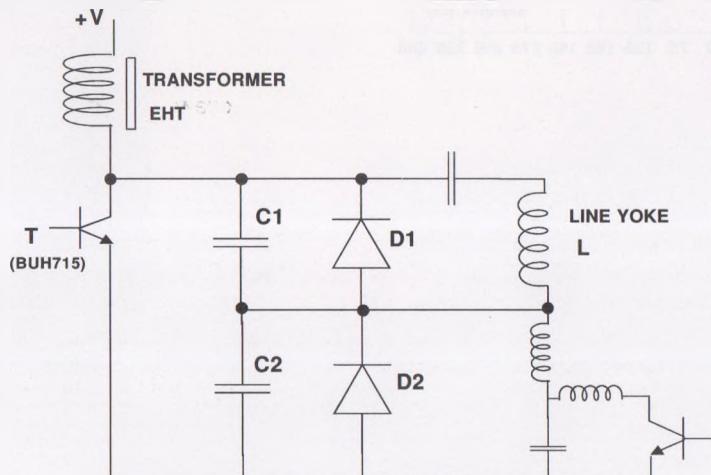
Fig.15 : Recovery time versus dI_F/dt .



BASIC HORIZONTAL DEFLECTION CIRCUIT



BASIC E-W DIODE MODULATOR CIRCUIT



D1=DTV32-1500

D2=BYT08-400